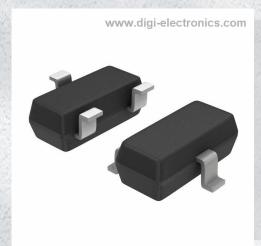


# **CPH3360-TL-H Datasheet**



https://www.DiGi-Electronics.com

DiGi Electronics Part Number CPH3360-TL-H-DG

Manufacturer onsemi

Manufacturer Product Number CPH3360-TL-H

Description MOSFET P-CH 30V 1.6A 3CPH

Detailed Description P-Channel 30 V 1.6A (Ta) 900mW (Ta) Surface Mou

nt 3-CPH



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



### **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
CPH3360-TL-H	onsemi
Series:	Product Status:
	Obsolete
FET Type:	Technology:
P-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
30 V	1.6A (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
4V, 10V	303m0hm @ 800mA, 10V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
	2.2 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	82 pF @ 10 V
FET Feature:	Power Dissipation (Max):
	900mW (Ta)
Operating Temperature:	Mounting Type:
150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
3-CPH	TO-236-3, SC-59, SOT-23-3
Base Product Number:	
CPH336	

## **Environmental & Export classification**

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8541.21.0095

# Power MOSFET –30V, 303mΩ, –1.6A, Single P-Channel

This Power MOSFET is produced using ON Semiconductor's trench technology, which is specifically designed to minimize gate charge and low on resistance. This device is suitable for applications with low gate charge driving or low on resistance requirements.

#### **Features**

- High Speed Switching
- 4V drive
- Pb-Free, Halogen Free and RoHS compliance

#### **Typical Applications**

• DC/DC Converter

#### **SPECIFICATIONS**

ABSOLUTE MAXIMUM RATING at Ta = 25°C (Note 1, 2)

Parameter	Symbol	Value	Unit
Drain to Source Voltage	VDSS	-30	V
Gate to Source Voltage	VGSS	±20	V
Drain Current (DC)	ID	-1.6	Α
Drain Current (Pulse) PW ≤ 10µs, duty cycle ≤ 1%	IDP	-6.4	Α
Power Dissipation When mounted on ceramic substrate (900mm²×0.8mm)	PD	0.9	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	°C

- Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
  - 2 : This product is designed to "ESD immunity<200V\*", so please take care when handling.
    - \*Machine Model

#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient When mounted on ceramic substrate (900mm² × 0.8mm)	$R_{\theta JA}$	138.8	°C/W

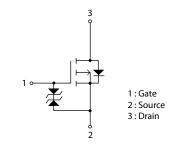


#### ON Semiconductor®

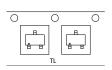
www.onsemi.com

VDSS	R <sub>DS</sub> (on) Max	I <sub>D</sub> Max
	303mΩ@ –10V	
-30V	532mΩ@ –4.5V	-1.6A
	617mΩ@ –4V	

## ELECTRICAL CONNECTION P-Channel



#### **PACKING TYPE: TL**





#### **ORDERING INFORMATION**

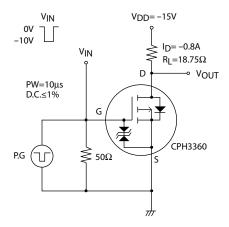
See detailed ordering and shipping information on page 5 of this data sheet.

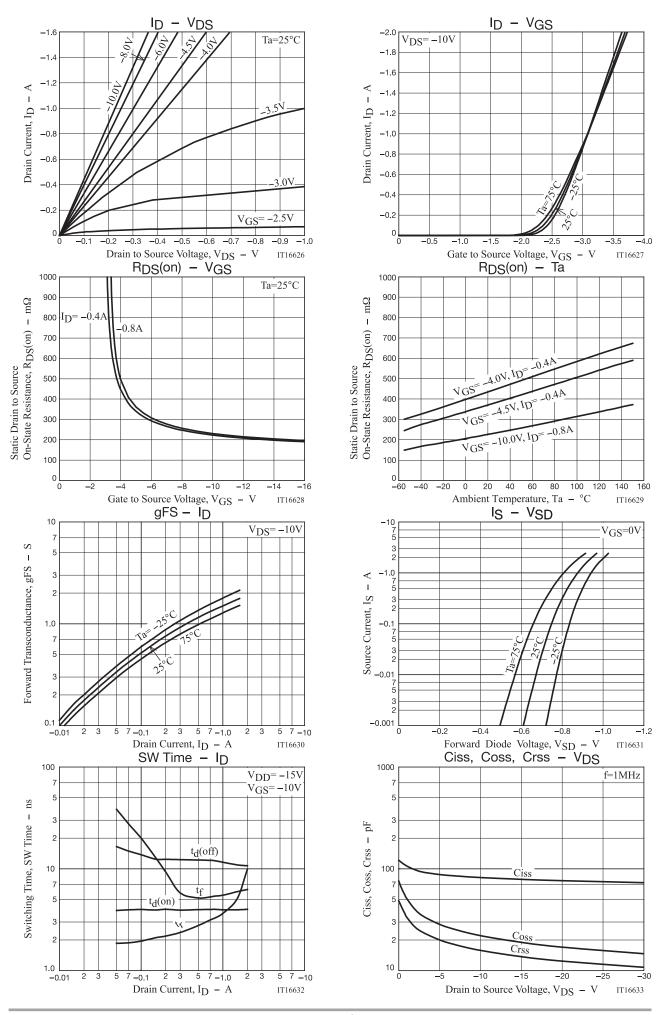
#### **ELECTRICAL CHARACTERISTICS** at $Ta = 25^{\circ}C$ (Note 3)

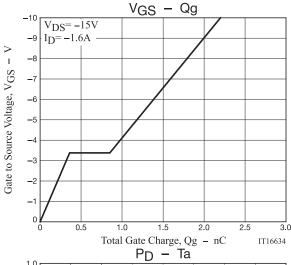
Parameter	Cumbal	Conditions	Value			Unit	
Parameter	Symbol	Conditions	min	typ	max	Unit	
Drain to Source Breakdown Voltage	V(BR)DSS	ID=-1mA, VGS=0V	-30			٧	
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V			-1	μΑ	
Gate to Source Leakage Current	IGSS	V <sub>GS</sub> =±16V, V <sub>DS</sub> =0V			±10	μΑ	
Gate Threshold Voltage	VGS(th)	V <sub>DS</sub> =-10V, I <sub>D</sub> =-1mA	-1.2		-2.6	V	
Forward Transconductance	gFS	V <sub>DS</sub> =-10V, I <sub>D</sub> =-0.8A		1.3		S	
	R <sub>DS</sub> (on)1	I <sub>D</sub> =-0.8A, V <sub>G</sub> S=-10V		233	303	mΩ	
Static Drain to Source On-State Resistance	R <sub>DS</sub> (on)2	I <sub>D</sub> =-0.4A, V <sub>G</sub> S=-4.5V		380	532	mΩ	
	R <sub>DS</sub> (on)3	I <sub>D</sub> =-0.4A, V <sub>G</sub> S=-4V		441	617	mΩ	
Input Capacitance	Ciss			82		pF	
Output Capacitance	Coss	V <sub>DS</sub> =-10V, f=1MHz		22		pF	
Reverse Transfer Capacitance	Crss			16		pF	
Turn-ON Delay Time	t <sub>d</sub> (on)			4.0		ns	
Rise Time	tr	Con an arified Took Circuit		3.3		ns	
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit		12		ns	
Fall Time	tf			5.4		ns	
Total Gate Charge	Qg			2.2		nC	
Gate to Source Charge	Qgs	V <sub>DS</sub> =-15V, V <sub>GS</sub> =-10V, I <sub>D</sub> =-1.6A		0.36		nC	
Gate to Drain "Miller" Charge	Qgd			0.49		nC	
Forward Diode Voltage	V <sub>SD</sub>	IS=-1.6A, VGS=0V		-0.9	-1.5	V	

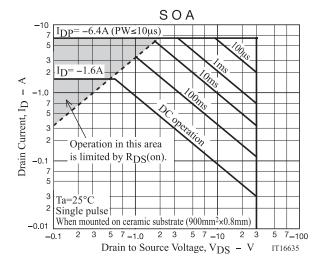
Note 3 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

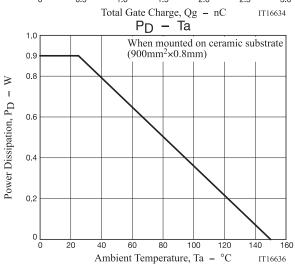
#### **Switching Time Test Circuit**

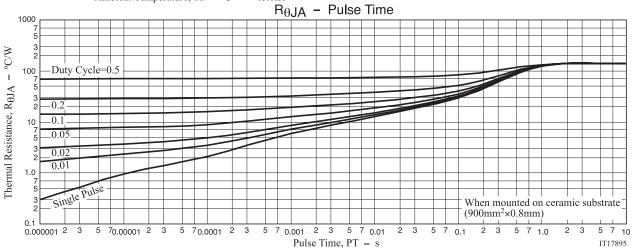






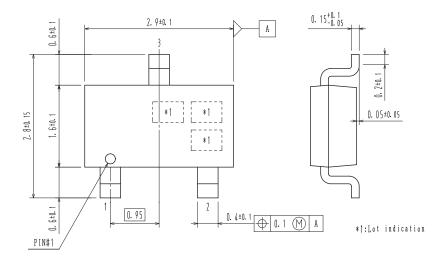






#### **PACKAGE DIMENSIONS**

unit: mm CPH3 CASE 318BA ISSUE O



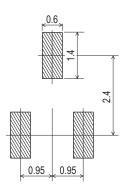
# 0.940.05

1 : Gate

2 : Source

3: Drain

#### Recommended Soldering Footprint



#### ORDERING INFORMATION

ONDERNING INTORNIATION					
Device	Marking	Package	Shipping (Qty / Packing)		
CPH3360-TL-H	ws	CPH3 SC-59, SOT-23, TO-236	2 000 / Tana & Baal		
CPH3360-TL-W	VVS	(Pb-Free / Halogen Free)	3,000 / Tape & Reel		

<sup>†</sup> For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub\_link/Collateral/BRD8011-D.PDF

Note on usage: Since the CPH3360 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

ON Semiconductor and the ON logo are registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent re



#### **OUR CERTIFICATE**

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com

















Tel: +00 852-30501935